2SB1174

Silicon PNP epitaxial planar type

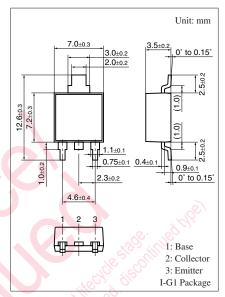
For voltage switching

■ Features

- Low collector-emitter saturation voltage V_{CE(sat)}
- Satisfactory linearity of forward current transfer ratio h_{FE}
- Large collector current I_C
- I type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	-130	V	
Collector-emitter voltage (Base open)	V _{CEO}	-80	V	
Emitter-base voltage (Collector open)	V_{EBO}	-7	V	
Collector current	I_C	-3	A	
Peak collector current	I_{CP}	-6	А	
Collector power dissipation	P _C	15	W	
$T_a = 25^{\circ}C$		1.3		
Junction temperature	T_{j}	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	



Note) Self-supported type package is also prepared.

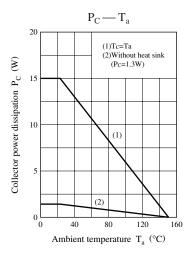
■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

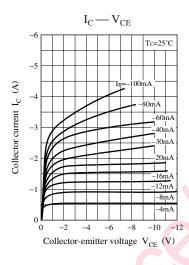
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = -10 \text{ mA}, I_B = 0$	-80			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = -100 \text{ V}, I_E = 0$			-10	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = -5 \text{ V}, I_C = 0$			-50	μΑ
Forward current transfer ratio	h _{FE1}	$V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$	45			_
	h _{FE2} *	$V_{CE} = -2 \text{ V}, I_{C} = -0.5 \text{ A}$	90		260	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -2 A, I_B = -0.1 A$			- 0.5	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = -2 A, I_B = -0.1 A$			-1.5	V
Transition frequency	f_T	$V_{CE} = -10 \text{ V}, I_{C} = -0.5 \text{ A}, f = 10 \text{ MHz}$		30		MHz
Turn-on time	t _{on}	$I_C = -0.5 \text{ A}, I_{B1} = -50 \text{ mA}, I_{B2} = 50 \text{ mA}$		0.3		μs
Storage time	t _{stg}	$V_{CC} = -50 \text{ V}$		1.1		μs
Fall time	$t_{\rm f}$			0.3		μs

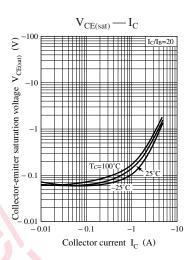
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

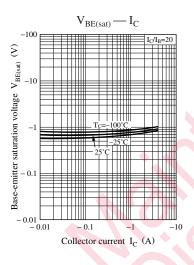
2. *: Rank classification

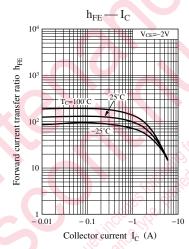
Rank	Q	Р
h _{FE2}	90 to 180	130 to 260

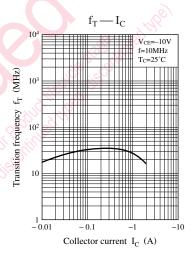


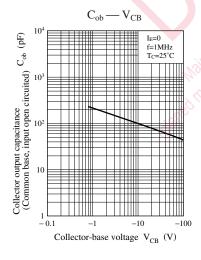


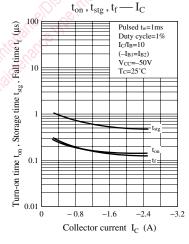


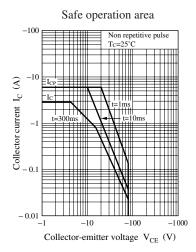


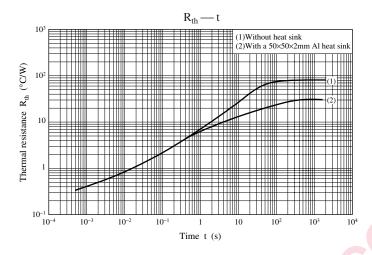












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